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To: Honorable Commissioner of Patents and Trademarks: Please record the attached original document(s) or copy thereof. 1. Name and address of conveying party(ies) Name: Strasbaugh Address: 825 Buckley Road, San Luis Obispo, CA 93401 Name and address of receiving party(ies): 2. Name: Lam Research Corporation Address: 4650 Cushing Parkway, Fremont, CA 94538 3. Nature of conveyance Assignment Merger Change of Name Security Agreement License Agreement Execution Date: December 19, 2000 Application Number: 09/038,875 4. The title of the application is: PARALLEL ALIGNMENT METHOD AND APPARATUS FOR CHEMICAL MECHANICAL POLISHING Please send all correspondence concerning this (these) documents to: 5. Albert S. Penilla, Esq. MARTINE PENILLA & KIM, LLP 710 Lakeway Drive, Suite 170 Sunnyvale, CA 94085 **Customer Number 25920** Tel. No. (408) 749-6900 Fax No.: (408) 749-6901 Total number of applications and patents involved: 1 6. Total fee (37 CFR 3.41): \$40.00 7. Enclosed Authorized to be charged to Deposit Account No. 50-0805 (Order No.____) To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. 8. Date: January 29, 2001 Albert'S. Penilla, Esq. Registration No. 39,487 00000336 09038875 02/13/2001 GTON11

(Revised 01/96)

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PATENT ASSIGNMENT

THIS PATENT ASSIGNMENT (the "Assignment") is entered into as of December 20, 2000, by Strasbaugh, a California corporation having its principal place of business located at 825 Buckley Road, San Luis Obispo, California ("Seller"), for the benefit of Lam Research Corporation, a Delaware corporation having its principal place of business located at 4650 Cushing Parkway, Fremont, California (the "Company").

RECITALS

WHEREAS, Seller and the Company are party to a certain Assignment Agreement dated as of December 20, 2000, pursuant to which Seller has agreed to assign, among other things, certain intellectual property to the Company:

NOW, THEREFORE, in consideration of the foregoing and the mutual promises contained herein and other good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, the parties agree as follows:

ASSIGNMENT

- 1. <u>Seller Patents</u>. For purposes of this Assignment, "Seller Patents" shall mean each of the patents, patents pending and patent applications listed on *Schedule 1* hereto, and (i) any other patent rights owned or controlled by Seller in patents and patent applications, and the inventions covered by those applications and patents, and Foreign Counterparts (as defined below) thereof, (ii) any additional patent rights Seller now owns, controls or has access to, or may own, control or have access to in the future which are now continuations, continuations-in-part, divisionals or substitutes of the original applications upon which the aforementioned patent rights are based, and the inventions covered thereby, or Foreign Counterparts thereof, and upon any reexaminations, reissues, renewals or extensions thereof, and (iii) any improvements patented by Seller. "Foreign Counterparts" shall mean all foreign patent applications and issued foreign patents, which claim priority from, or share common priority with, an identified United States patent or patent application, or which claim and disclose substantially similar inventions that are the subject matter of such identified United States patent or patent applications.
- 2. <u>Assignment</u>. Seller hereby assigns, transfers and conveys to the Company all of Seller's rights, title and interest throughout the world in and to the Seller Patents, the underlying inventions described therein, and all rights, claims and privileges pertaining to the Seller Patents.
- 3. <u>Effective Date</u>. This Assignment shall be effective as of the date set forth above.

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PATENT REEL: 011507 FRAME: 0155

IN WITNESS WHEREOF, the undersigned has executed this Assignment as of the date first written above. STRASBAUGH, a California corporation. Title: On this And day of December, in the year of 2000, before me, the undersigned notary public, personally appeared the above-named assignor, known to me (or proved to me on the basis of satisfactory evidence) to be the person whose name is subscribed to the within instrument, and acknowledged that he executed the same. Acknowledged: YELENA A. WILLIAMS LAM RESEARCH CORPORATION, a Delaware corporation

n H. Meller By: _____ Name:

Date: _____, 2000

Title:

PATENT REEL: 011507 FRAME: 0156 IN WITNESS WHEREOF, the undersigned has executed this Assignment as of the date first written above.

STRASBAUGH, a California corporation.

By: __ Name:

Title:

CL

Acknowledged:

LAM RESEARCH CORPORATION, a Delaware corporation

By: _

Name: STEPHEN G. NEW

Date: _____, 2000

PATENT

REEL: 011507 FRAME: 0157

SCHEDULE 1

Seller Patents

Legend			
Boyd	John Boyd		
Fuhriman	John Fuhriman		
Halley	David G. Halley		
Kalenian	William J. Kallenian		
Lentz	Terry Lentz		
Strasbaugh	Alan Strasbaugh		
Treur	Randy Treur		
Vogtmann	Michael Vogtmann		
Walsh	Jeffrey A. Walsh		
Wells	Carlton Wells		
Wolf	Stephan Wolf		

Description of Invention	Inventor	Patent or Application Number
Wafer Carrier For Film Planarization	Strasbaugh	US Patent 5,449,316 Application 08/178,531
Apparatus For Sensing The Presence Of A Wafer	Kalenian, Lentz	US Patent 5,961,169 Application 09/124,160
		International Patent Application No. PCT/US99/17037
Wafer Handling Apparatus Having A Resilient Membrane Which Holds Wafer	Strasbaugh	US Patent 5,423,716 Application 80/178,530
G. Lal Paine Drive	Halley	Provisional 60/215,666
Projected Gimbal Point Drive Accurate Positioning of a Wafer	Vogtmann	US Patent 6,131,589
		Application 09/247,108
		International Patent Application No. PCT/US99/02699
Non-Contacting Support For A	Vogtmann	Application 09/247,107
Wafer Sensing The Presence of a Wafer	Vogtmann	Application 09/247,108
		International Patent Application No. PCT/US99/02699

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PATENT REEL: 011507 FRAME: 0158

Description of Invention	Inventor	Patent or Application Number
Lifting And Rinsing A Wafer	Vogtmann	US Patent 6,102,057 Application 09/247,109 International Patent Application No. PCT/US99/02699
Parallel Alignment Method And Apparatus For Chemical Mechanical Polishing	Walsh, Fuhriman, Wells	Application 09/038,875
Optical Viewport for CMP Endpoint Detection	Treur, Wolf, Boyd	US Patent 6,146,242 Application 09/330,472 International Patent Application No. PCT/US00/16026

RECORDED: 02/02/2001